# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3529917

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
WEN-DE WANG	02/23/2010
DUN-NIAN YAUNG	02/23/2010
JEN-CHENG LIU	02/23/2010
CHUN-CHIEH CHUANG	02/23/2010
JENG-SHYAN LIN	02/23/2010

#### RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	NO. 8, LI-HSIN RD. VI, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300

## **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	14856624	

## **CORRESPONDENCE DATA**

**Fax Number:** (703)518-5499

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7036841111
Email: tsmc@ipfirm.com

Correspondent Name: HAUPTMAN HAM, LLP (TSMC)

Address Line 1: 2318 MILL ROAD SUITE 1400

Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:	T5057-R015UA	
NAME OF SUBMITTER:	RANDY A. NORANBROCK	
SIGNATURE:	/Randy A. Noranbrock/	
DATE SIGNED:	09/17/2015	
	•	

**Total Attachments: 2** 

PATENT REEL: 036587 FRAME: 0110

503483292

source=efiledassgn#page1.tif		
source=efiledassgn#page2.tif		

PATENT REEL: 036587 FRAME: 0111

Docket No.: T5057-R015U

# **ASSIGNMENT**

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Wen-De WANG
- 4) Chun-Chieh CHUANG
- 2) Dun-Nian YAUNG

SIGNED on the date indicated aside my signature:

5) Jeng-Shyan LIN

3) Jen-Cheng LIU

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

# TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD. having a place of business at No.

## 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan 300, R.O.C.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

#### PAD DESIGN FOR BACKSIDE ILLUMINATED IMAGE SENSOR

- (a) for which an application for United States Letters Patent was filed on February 18, 2010, and identified by United States Patent Application No. 12/708,167; or
- (b) for which an application for United States Letters Patent was executed on \_\_\_\_\_

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1) <u>Ubn-De Wang</u>
Name: Wen-De WANG

2) <u>Shur-Yim</u> Jaung
Name: Dun-Nian YAUNG

Date:

Name: Jen-Cheng Liu Date:

Name: Chun-Chich Chuang

Name: Chun-Chich CHUANG

Date:

5) / Jeng-Shyan Lin Name: Jeng-Shyan LIN/ / 2/23/10

Date:

PATENT REEL: 036587 FRAME: 0113

**RECORDED: 09/17/2015**